Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Тор	Copper	0.035mm	
5		Dielectric 1	FR-4	0.500mm	4.8
6		Signal Layer 1	Copper	0.036mm	
7		Dielectric 5		0.127mm	4.2
8		Signal Layer 2	Copper	0.036mm	
9		Dielectric 4		0.254mm	4.2
10		Route2	Copper	0.035mm	
11		Dielectric 2	FR-4	0.127mm	4.2
12		Route15	Copper	0.035mm	
13		Dielectric 3	FR-4	0.254mm	4.2
14		Bottom	Copper	0.035mm	
15		Bottom Solder	Solder Resist	0.010mm	3.5
16		Bottom Overlay			
17		Bottom Paste			
	Height : 1.494mm				